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TAPE Attachment Method

Part Number: 364424B00034G

RoHS √ Compliant

Printer Friendly Version Download our BGA Brochure (PDF)

BGA Surface	Таре Туре	Heat Sink Finish		
Plastic	T410R	Black Anodize		

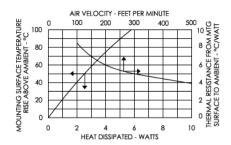
Features and Benefits

- Tape mounting saves board space by eliminating mounting
- Convenient peel and stick assembly is quick and clean
- Pin Fin array allows omni -directional airflow to maximize heat



Width	Length	Height	Fin Thickness Across Width	Fin Thickness Across Length	Base Thickness	# of fins across width	# of fins across length
40.1mm	40mm	11.4mm	1.02mm	0.89mm	2.54mm	13	13

Mechanical Outline Drawing

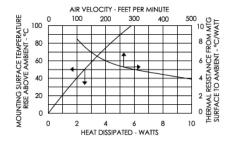


Unless otherwise shown, tolerances are

 $\pm 0.38(\pm .015)$

Thermal Performance

* ? n ** ? f 18.4 6.02



- * Natural convection thermal resistance is based on a 75 °C heat sink temperature rise.
- ** Forced convection thermal resistance based on an entering 1.0 m/s (200 lfm) airflow. Due to various heat dissipation paths within a BGA device, please test the heat sink in your application.

This data sheet represents only one of a broad range of products we make to cool electronics. Our representatives can help you configure a complete cooling solution for your individual applications.

For more information on how to put our strengths to work for you, contact your local sales

http://www.aavidthermalloy.com/sales/reps.shtml